

SMALL SIGNAL NPN TRANSISTOR

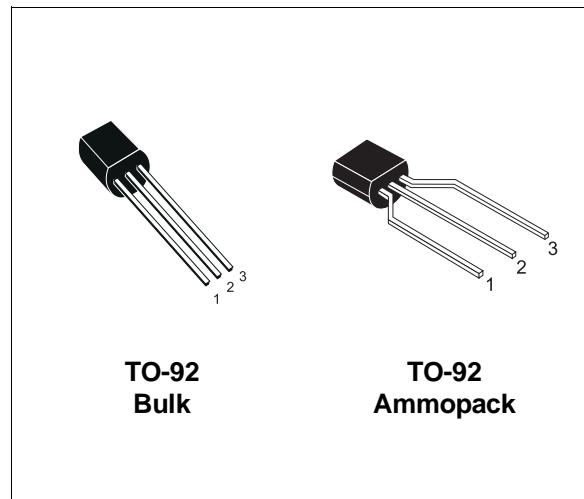
PRELIMINARY DATA

Ordering Code	Marking	Package / Shipment
2N3904	2N3904	TO-92 / Bulk
2N3904-AP	2N3904	TO-92 / Ammopack

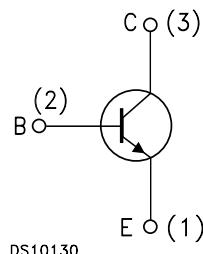
- SILICON EPITAXIAL PLANAR NPN TRANSISTOR
- TO-92 PACKAGE SUITABLE FOR THROUGH-HOLE PCB ASSEMBLY
- THE PNP COMPLEMENTARY TYPE IS 2N3906

APPLICATIONS

- WELL SUITABLE FOR TV AND HOME APPLIANCE EQUIPMENT
- SMALL LOAD SWITCH TRANSISTOR WITH HIGH GAIN AND LOW SATURATION VOLTAGE



INTERNAL SCHEMATIC DIAGRAM



DS10130

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage ($I_E = 0$)	60	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	40	V
V_{EBO}	Emitter-Base Voltage ($I_C = 0$)	6	V
I_C	Collector Current	200	mA
P_{tot}	Total Dissipation at $T_C = 25^\circ\text{C}$	625	mW
T_{stg}	Storage Temperature	-65 to 150	$^\circ\text{C}$
T_j	Max. Operating Junction Temperature	150	$^\circ\text{C}$

2N3904

THERMAL DATA

$R_{\text{thj-amb}}$	• Thermal Resistance Junction-Ambient	Max	200	$^{\circ}\text{C}/\text{W}$
$R_{\text{thj-case}}$	• Thermal Resistance Junction-Case	Max	83.3	$^{\circ}\text{C}/\text{W}$

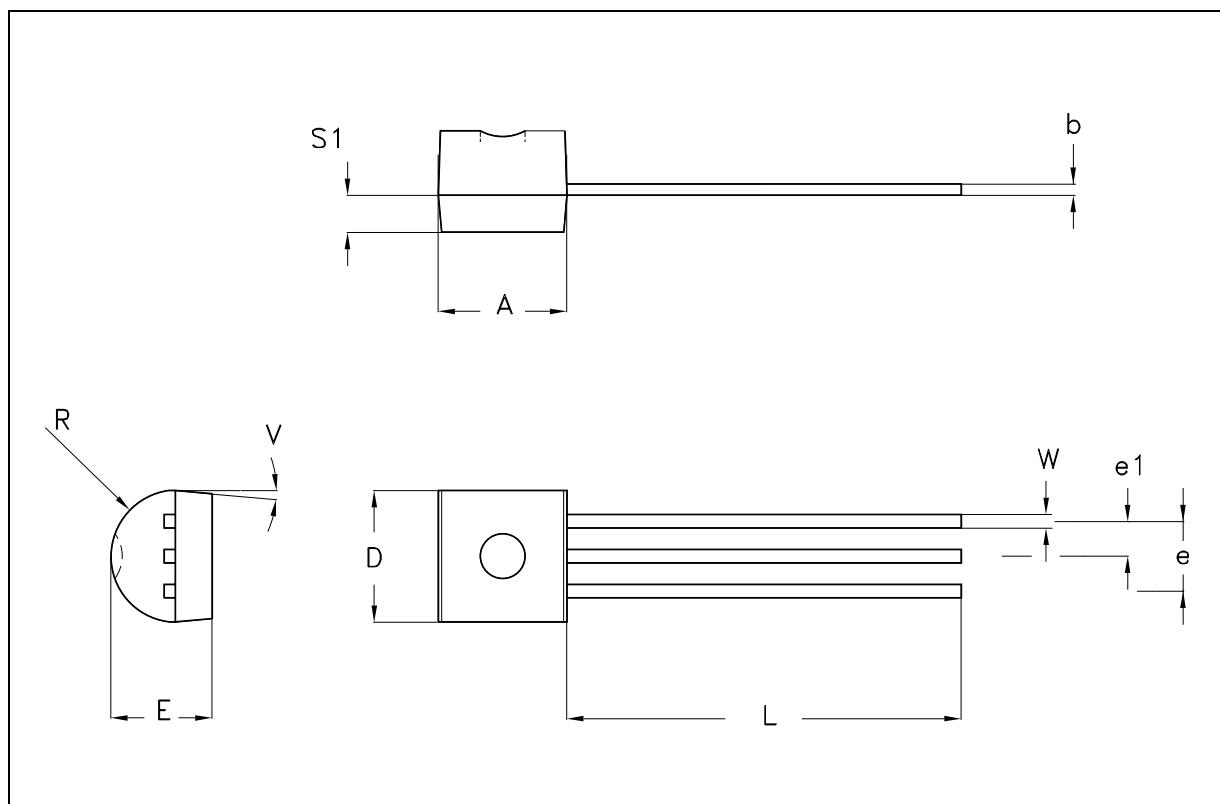
ELECTRICAL CHARACTERISTICS ($T_{\text{case}} = 25 \ ^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
I_{CEX}	Collector Cut-off Current ($V_{\text{BE}} = -3 \text{ V}$)	$V_{\text{CE}} = 30 \text{ V}$				50	nA
I_{BEX}	Base Cut-off Current ($V_{\text{BE}} = -3 \text{ V}$)	$V_{\text{CE}} = 30 \text{ V}$				50	nA
$V_{(\text{BR})\text{CEO}}^*$	Collector-Emitter Breakdown Voltage ($I_B = 0$)	$I_C = 1 \text{ mA}$		40			V
$V_{(\text{BR})\text{CBO}}$	Collector-Base Breakdown Voltage ($I_E = 0$)	$I_C = 10 \mu\text{A}$		60			V
$V_{(\text{BR})\text{EBO}}$	Emitter-Base Breakdown Voltage ($I_C = 0$)	$I_E = 10 \mu\text{A}$		6			V
$V_{\text{CE}(\text{sat})}^*$	Collector-Emitter Saturation Voltage	$I_C = 10 \text{ mA}$ $I_B = 1 \text{ mA}$ $I_C = 50 \text{ mA}$ $I_B = 5 \text{ mA}$				0.2 0.2	V V
$V_{\text{BE}(\text{sat})}^*$	Base-Emitter Saturation Voltage	$I_C = 10 \text{ mA}$ $I_B = 1 \text{ mA}$ $I_C = 50 \text{ mA}$ $I_B = 5 \text{ mA}$		0.65		0.85 0.95	V V
h_{FE}^*	DC Current Gain	$I_C = 0.1 \text{ mA}$ $V_{\text{CE}} = 1 \text{ V}$ $I_C = 1 \text{ mA}$ $V_{\text{CE}} = 1 \text{ V}$ $I_C = 10 \text{ mA}$ $V_{\text{CE}} = 1 \text{ V}$ $I_C = 50 \text{ mA}$ $V_{\text{CE}} = 1 \text{ V}$ $I_C = 100 \text{ mA}$ $V_{\text{CE}} = 1 \text{ V}$	60 80 100 60 30			300	
f_T	Transition Frequency	$I_C = 10 \text{ mA}$ $V_{\text{CE}} = 20 \text{ V}$ $f = 100 \text{ MHz}$	250	270			MHz
C_{CBO}	Collector-Base Capacitance	$I_E = 0$ $V_{\text{CB}} = 10 \text{ V}$ $f = 1 \text{ MHz}$			4		pF
C_{EBO}	Emitter-Base Capacitance	$I_C = 0$ $V_{\text{EB}} = 0.5 \text{ V}$ $f = 1 \text{ MHz}$			18		pF
NF	Noise Figure	$V_{\text{CE}} = 5 \text{ V}$ $I_C = 0.1 \text{ mA}$ $f = 10 \text{ Hz}$ to 15.7 KHz $R_G = 1 \text{ K}\Omega$			5		dB
t_d t_r	Delay Time Rise Time	$I_C = 10 \text{ mA}$ $I_B = 1 \text{ mA}$ $V_{\text{CC}} = 30 \text{ V}$				35 35	ns ns
t_s t_f	Storage Time Fall Time	$I_C = 10 \text{ mA}$ $I_{B1} = -I_{B2} = 1 \text{ mA}$ $V_{\text{CC}} = 30 \text{ V}$				200 50	ns ns

* Pulsed: Pulse duration = 300 μs , duty cycle $\leq 2 \%$

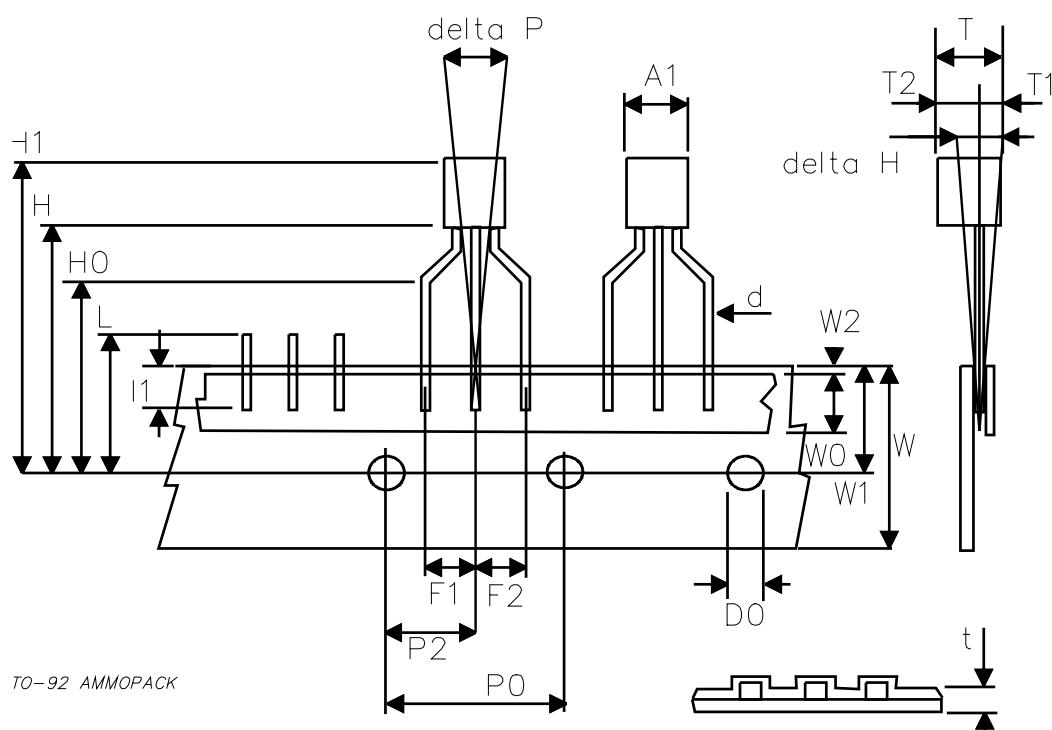
TO-92 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.32		4.95	0.170		0.195
b	0.36		0.51	0.014		0.020
D	4.45		4.95	0.175		0.194
E	3.30		3.94	0.130		0.155
e	2.41		2.67	0.095		0.105
e1	1.14		1.40	0.045		0.055
L	12.70		15.49	0.500		0.609
R	2.16		2.41	0.085		0.094
S1	1.14		1.52	0.045		0.059
W	0.41		0.56	0.016		0.022
V	4 degree		6 degree	4 degree		6 degree



TO-92 AMMOPACK SHIPMENT (Suffix "-AP") MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A1			4.80			0.189
T			3.80			0.150
T1			1.60			0.063
T2			2.30			0.091
d			0.48			0.019
P0	12.50	12.70	12.90	0.492	0.500	0.508
P2	5.65	6.35	7.05	0.222	0.250	0.278
F1,F2	2.44	2.54	2.94	0.096	0.100	0.116
delta H	-2.00		2.00	-0.079		0.079
W	17.50	18.00	19.00	0.689	0.709	0.748
W0	5.70	6.00	6.30	0.224	0.236	0.248
W1	8.50	9.00	9.25	0.335	0.354	0.364
W2			0.50			0.020
H	18.50		20.50	0.728		0.807
H0	15.50	16.00	16.50	0.610	0.630	0.650
H1			25.00			0.984
D0	3.80	4.00	4.20	0.150	0.157	0.165
t			0.90			0.035
L			11.00			0.433
I1	3.00			0.118		
delta P	-1.00		1.00	-0.039		0.039



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